#### 503323492 05/27/2015

## PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT3370110

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
SZU-LIN LIU	05/14/2015
JAW-JUINN HORNG	05/14/2015

#### **RECEIVING PARTY DATA**

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY LTD.	
Street Address:	NO.8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK	
City:	HSINCHU	
State/Country:	TAIWAN	

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14722714

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NAME OF SUBMITTER:	ANTHONY KING
SIGNATURE:	/Anthony King/
DATE SIGNED:	05/27/2015

**Total Attachments: 2** 

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> **PATENT REEL: 035722 FRAME: 0665** 503323492

# **ASSIGNMENT**

Jihorng boiszobzia hascolsk

WHEREAS, I(we), <u>LIU</u>, <u>SZU-LIN</u>, and <u>HORNG</u>, <u>JAW-JUINN</u>, whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR, have invented certain new and useful invention entitled

### SEMICONDUCTOR DEVICE AND LAYLOUT METHOD THEREOF

(hereinafter referred to as the INVENT is executed on even date herewith unl ☐ United States Design Patent v	ess at least one of the following		ters Patent /Utility Patent
□ executed on:			
☐ filed on: ☐ established by PCT Internation United States of America ☐ issued on	• •	filed:	designating the
WHEREAS, <u>TAIWAN SEMICON</u> address is <u>NO.8</u> , <u>LI-HSIN RD.</u> hereinafter referred to as ASSIGNEE, ithe United States and its territorial po	6, HSINCHU SCIENCE is desirous of acquiring the enti	PARK, HSINCI	HU, TAIWAN, R.O.C.
NOW, THEREFORE, for good at ASSIGNOR, by these presents do sell, and to said INVENTION and applicat Patent granted on any division, continterms for which the same may be granted.	assign and transfer unto said A ion throughout the United Sta nuation, continuation-in-part an	ASSIGNEE, the entire tes of America, inc d reissue of said app	e right, title, and interest in luding any and all Letters lication for the full term or
ASSIGNOR further covenants the or entered into which would conflict v	nt no assignments, sale, agreem with this Assignment;	nent or encumbrance	e has been or will be made
ALSO, ASSIGNOR hereby agrees the filing, prosecution and maintenance of said INVENTION, including additional said INVENTION, all without further ASSIGNEE'S expense, to identify and concerning the INVENTION that are witestimony on behalf of ASSIGNEE the maintenance, litigation and defense instrument. ASSIGNOR'S obligation administrators and other legal representations.	of said application or any othe I documents that may be required consideration. ASSIGNOR also communicate to ASSIGNEE at A ithin ASSIGNOR'S possession or hat lawfully may be required of any patent application or any under this instrument shape.	r patent application( red to affirm the rig o agrees, without fu ASSIGNEE'S request of control, and to prov of ASSIGNOR in re patent encompassed	s) in the United States for hts of ASSIGNEE in and to orther consideration and at locuments and information vide further assurances and espect of the prosecution, I within the terms of this
ALSO. ASSIGNOR hereby authori and all Letters Patent referred to above the same, for ASSIGNEE'S sole use an successors, to the full end of the term same would have been held by ASSIGNEE'S	re to ASSIGNEE, as the ASSIGNE d behoof; and for the use and be n for which such Letters Pater	EE of the entire right behoof of ASSIGNEE'nt may be granted, a	, title and interest in and to S legal representatives and

Assignor Name LIU, SZU-LIN	Address  RM. 3, 2F., NO.58, ALY. 2, LN. 9, GAOCUI  RD., EAST DIST., HSINCHU CITY 300,  TAIWAN (R.O.C.)
Signature of Assignor (X) LIU SZU LIN	Date of Signature (X) > 7015 /5 /14
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

PATENT REEL: 035722 FRAME: 0666 jjhorng 2015/05/14 08:55:5

Assignor Name HORNG, JAW-JUINN	2F, NO. 31-1, LN. 145, BAOSHAN ROAD, HSINCHU 300, TAIWAN (R.O.C.)
Signature of Assignor (X)	Date of Signature (X) 2015/5/14
Name of Whiness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

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